



**N-Channel Enhancement Mode Power MOSFET**

**Description**  
The PED2310N uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. It can be used in a wide variety of applications. It is ESD protected.

**General Features**

- $V_{DS} = 18V, I_D = 7A$
- $R_{DS(ON)} < 16m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} < 17m\Omega @ V_{GS}=4.2V$
- $R_{DS(ON)} < 18m\Omega @ V_{GS}=3.8V$
- $R_{DS(ON)} < 24m\Omega @ V_{GS}=2.5V$
- ESD Rating: 4000V HBM
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

**Application**

- PWM applications
- Load switch
- Power management

**Schematic diagram**

**Marking**

**DFN2x3-6L**

**Absolute Maximum Ratings (TA=25°C unless otherwise noted)**

| Parameter  | Symbol         | Rating     | Unit |
|--|----------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | 18         | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 12$   | V    |
| Drain Current-Continuous                         | $I_D$          | 7          | A    |
| Pulsed Drain Current (Note 1)                    | $I_{DM}$       | 30         | A    |
| Maximum Power Dissipation                        | $P_D$          | 1.25       | W    |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | °C   |

**Thermal Characteristic**

|  |                 |     |      |
|--|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 100 | °C/W |
|--|-----------------|-----|------|



**Electrical Characteristics (TA=25°C unless otherwise noted)**

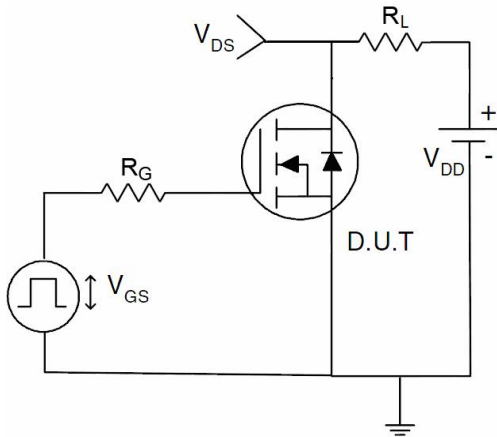
| Parameter                                 | Symbol       | Condition  | Min  | Typ  | Max      | Unit       |
|---|--------------|--|------|------|----------|------------|
| <b>Off Characteristics</b>                |              |  |      |      |          |            |
| Drain-Source Breakdown Voltage            | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$  | -    | 18   | -        | V          |
| Zero Gate Voltage Drain Current           | $I_{DSS}$    | $V_{DS}=16V, V_{GS}=0V$  | -    | -    | 1        | $\mu A$    |
| Gate-Body Leakage Current                 | $I_{GSS}$    | $V_{GS}=\pm 10V, V_{DS}=0V$                                      | -    | -    | $\pm 10$ | $\mu A$    |
| <b>On Characteristics (Note 3)</b>        |              |  |      |      |          |            |
| Gate Threshold Voltage                    | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                    | 0.45 | 0.7  | 1.0      | V          |
| Drain-Source On-State Resistance          | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=6.5A$  | 12   | 14   | 16       | m $\Omega$ |
|   |              | $V_{GS}=4.2V, I_D=6.5A$  | 12.5 | 14.2 | 17       | m $\Omega$ |
|   |              | $V_{GS}=3.8V, I_D=5.5A$  | 13   | 14.5 | 18       | m $\Omega$ |
|   |              | $V_{GS}=2.5V, I_D=5.5A$  | 17   | 19   | 24       | m $\Omega$ |
| Forward Transconductance                  | $g_{FS}$     | $V_{DS}=5V, I_D=7A$  | 15   | -    | -        | S          |
| <b>Dynamic Characteristics (Note 4)</b>   |              |  |      |      |          |            |
| Input Capacitance                         | $C_{iss}$    | $V_{DS}=10V, V_{GS}=0V,$<br>$F=1.0MHz$                           | -    | 760  | -        | pF         |
| Output Capacitance                        | $C_{oss}$    |  | -    | 205  | -        | pF         |
| Reverse Transfer Capacitance (Note 4)     | $C_{rss}$    |  | -    | 190  | -        | pF         |
| <b>Switching Characteristics</b>          |              |  |      |      |          |            |
| Turn-on Delay Time                        | $t_{d(on)}$  | $V_{DD}=10V, I_D=2A, R_L=1\Omega,$<br>$V_{GS}=4.5V, R_G=3\Omega$ | -    | 6    | -        | nS         |
| Turn-on Rise Time                         | $t_r$        |  | -    | 13   | -        | nS         |
| Turn-Off Delay Time                       | $t_{d(off)}$ |  | -    | 52   | -        | nS         |
| Turn-Off Fall Time                        | $t_f$        |  | -    | 16   | -        | nS         |
| Total Gate Charge                         | $Q_g$        | $V_{DS}=10V, I_D=5A,$<br>$V_{GS}=4.5V$                           | -    | 10   | -        | nC         |
| Gate-Source Charge                        | $Q_{gs}$     |  | -    | 1.1  | -        | nC         |
| Gate-Drain Charge                         | $Q_{gd}$     |  | -    | 4    | -        | nC         |
| <b>Drain-Source Diode Characteristics</b> |              |  |      |      |          |            |
| Diode Forward Voltage (Note 3)            | $V_{SD}$     | $V_{GS}=0V, I_S=1A$  | -    | -    | 1.2      | V          |
| Diode Forward Current (Note 2)            | $I_S$        |  | -    | -    | 7        | A          |

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to product.



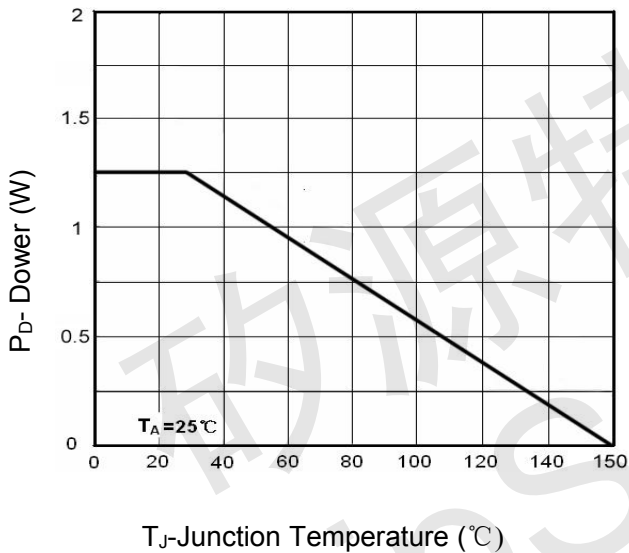
**Typical Electrical and Thermal Characteristics**



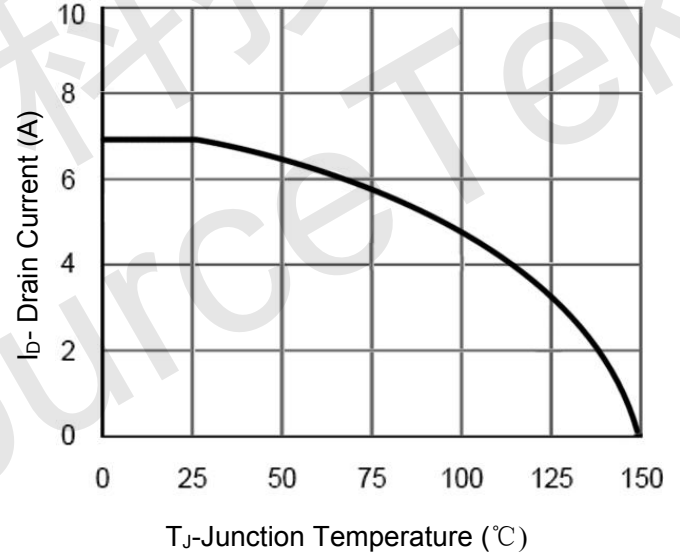
**Figure 1 Switching Test Circuit**



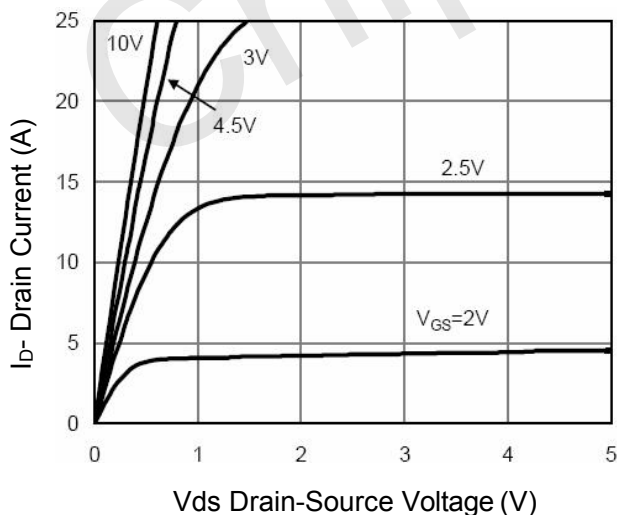
**Figure 2 Switching Waveform**



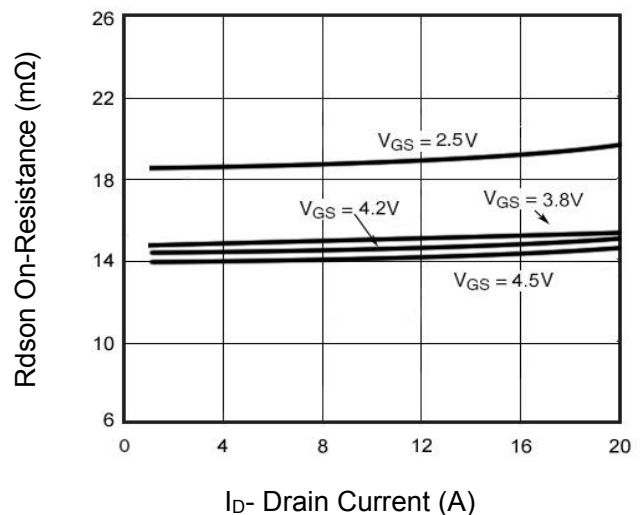
**Figure 3 Power Dissipation**



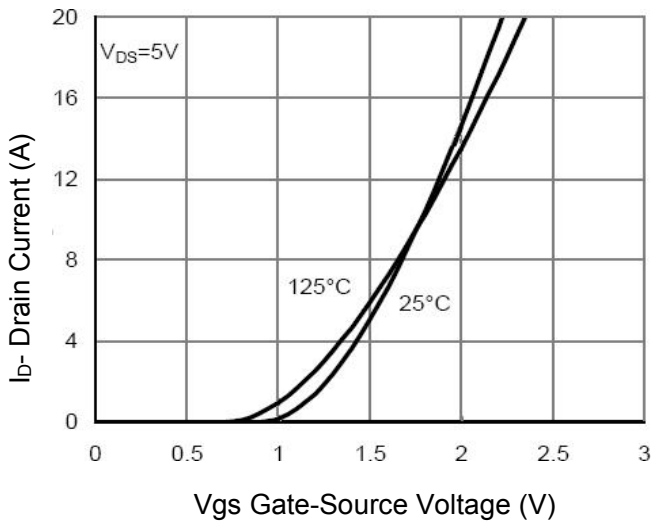
**Figure 4 Drain Current**



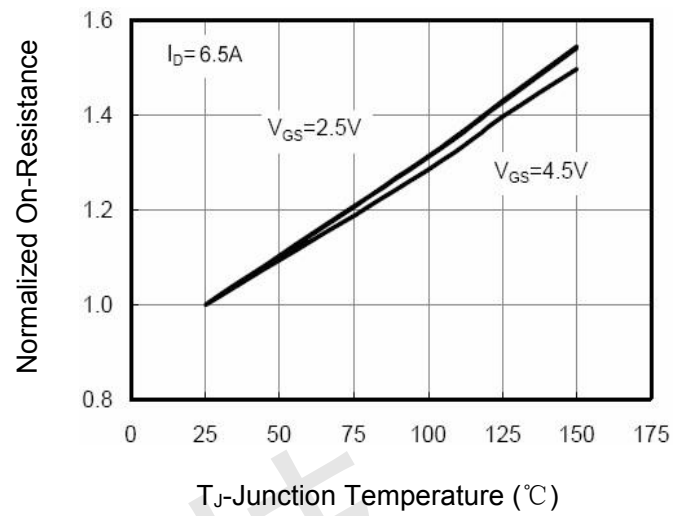
**Figure 5 Output Characteristics**



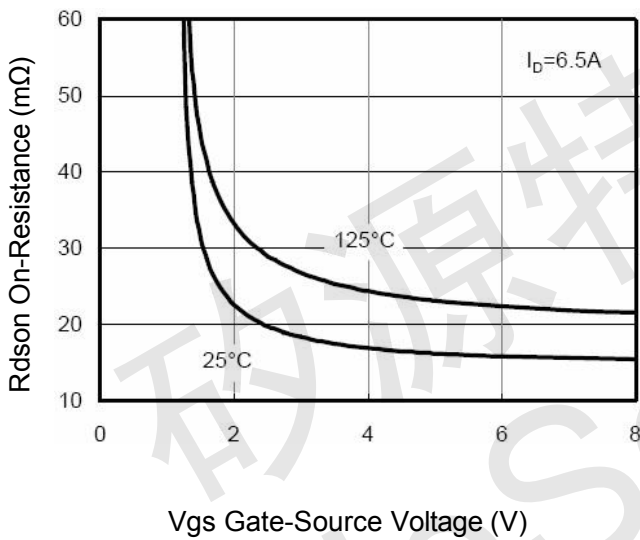
**Figure 6 R<sub>dson</sub> vs Drain Current**



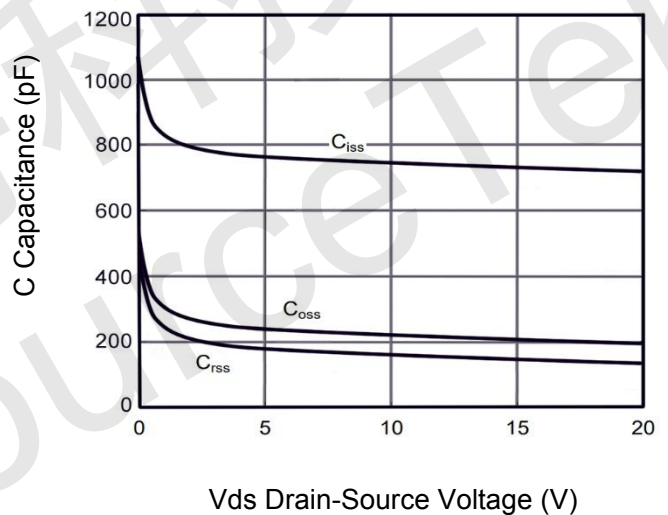
**Figure 7 Transfer Characteristics**



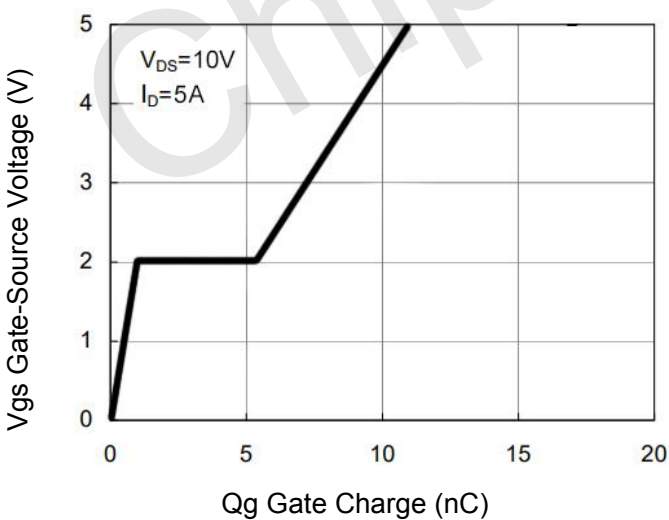
**Figure 8 Rdson vs Junction Temperature**



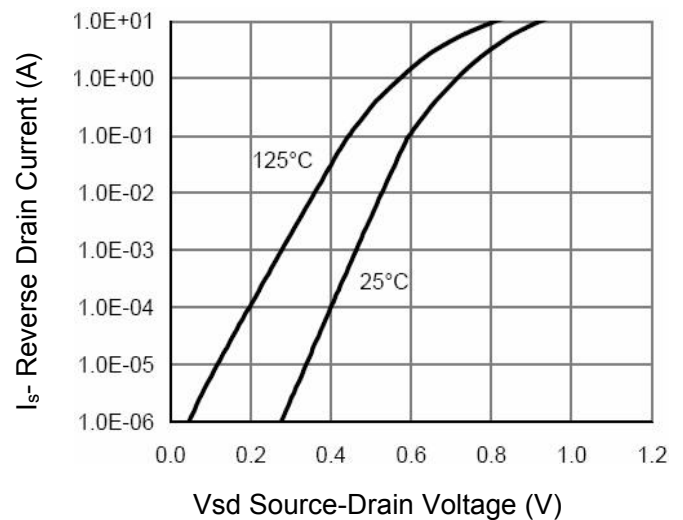
**Figure 9 Rdson vs Vgs**



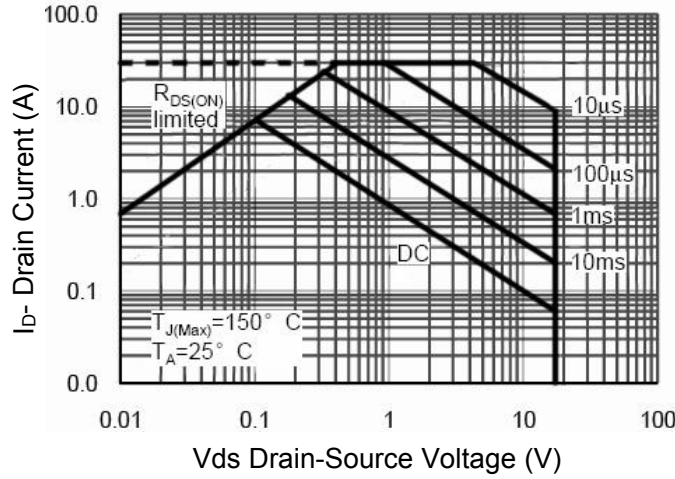
**Figure 10 Capacitance vs Vds**



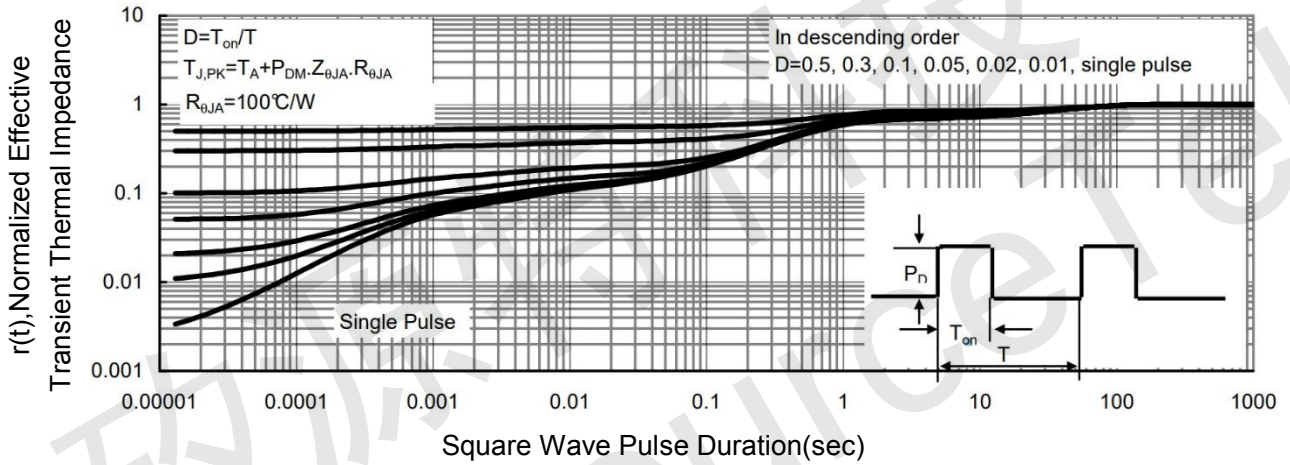
**Figure 11 Gate Charge**



**Figure 12 Source- Drain Diode Forward**



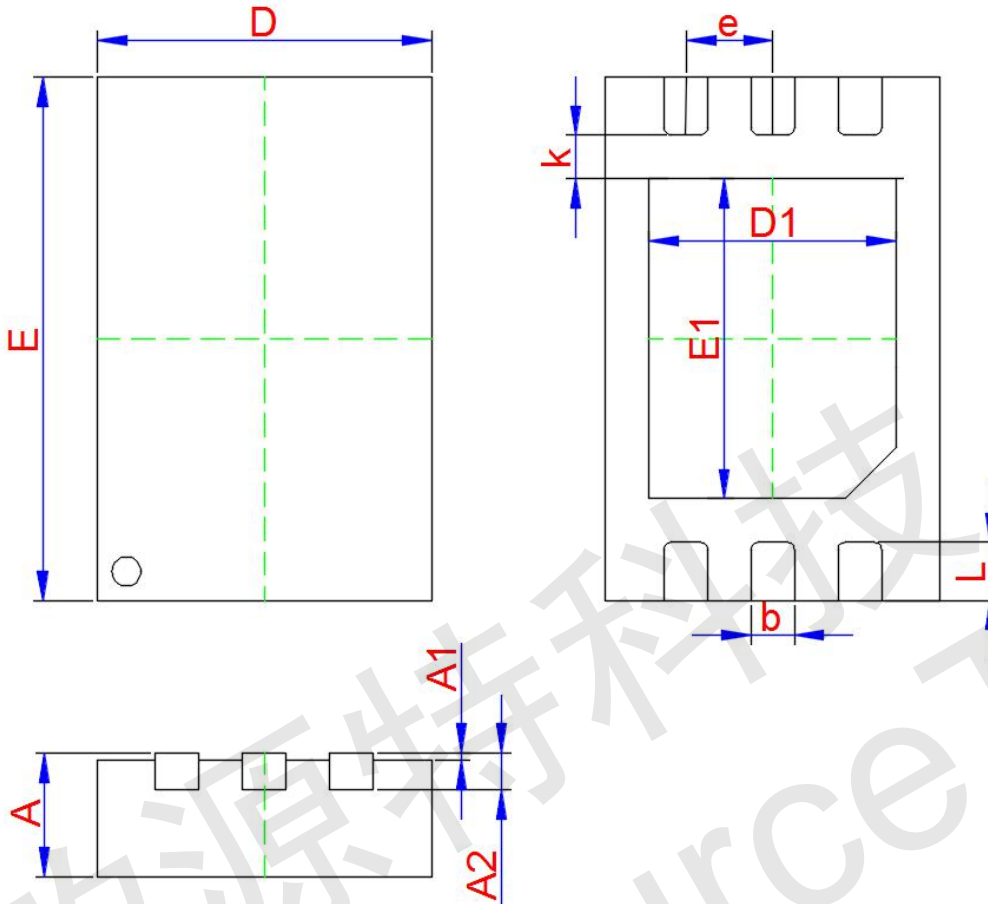
**Figure 13 Safe Operation Area**



**Figure 14 Normalized Maximum Transient Thermal Impedance**



**DFN2x3-6L Package Information**



| Symbol | Dimensions In Millimeters |       |       |
|--------|---------------------------|-------|-------|
|        | Min.                      | Typ.  | Max.  |
| A      | 0.700                     | 0.750 | 0.800 |
| A1     | 0.000                     | 0.020 | 0.050 |
| A2     | 0.203 TYP.                |       |       |
| D      | 1.950                     | 2.000 | 2.050 |
| E      | 2.950                     | 3.000 | 3.050 |
| D1     | 1.450                     | 1.500 | 1.550 |
| E1     | 1.650                     | 1.700 | 1.750 |
| k      | 0.200 MIN.                |       |       |
| b      | 0.200                     | 0.250 | 0.300 |
| e      | 0.500 TYP.                |       |       |
| L      | 0.300                     | 0.350 | 0.400 |